

IRK.F132.. SERIES

**FAST THYRISTOR/ DIODE and
 THYRISTOR/THYRISTOR**

INT-A-pak™ Power Modules

130 A

Features

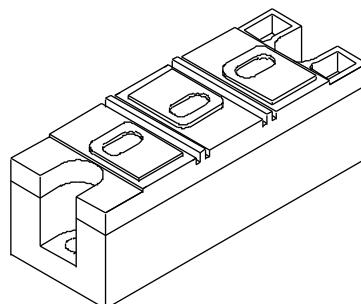
- Fast turn-off thyristor
- Fast recovery diode
- High surge capability
- Electrically isolated baseplate
- 3000 V_{RMS} isolating voltage
- Industrial standard package
- UL E78996 approved 

Description

These series of INT-A-pak modules are intended for applications such as self-commutated inverters, DC choppers, electronic welders, induction heating and others where fast switching characteristics are required.

Major Ratings and Characteristics

Parameters	IRK.F132..	Units
I _{T(AV)}	130	A
@ T _C	90	°C
I _{T(RMS)}	293	A
I _{TSM}	3210	A
@ 50Hz	3360	A
I ² t	51.5	KA ² s
@ 60Hz	47.0	KA ² s
I ² /t	515	KA ² /s
t _q	15	μs
t _{rr}	2	μs
V _{DRM} /V _{RRM}	up to 800	V
T _J range	-40 to 125	°C



IRK.F132.. Series

Bulletin I27092 rev. A 09/97

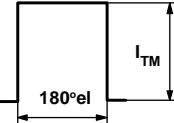
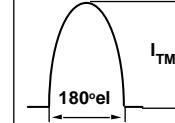
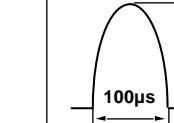
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ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM}/V_{DRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak rev. voltage V	I_{RRM}/I_{DRM} max. @ $T_J = 125^\circ\text{C}$ mA
IRK.F132..	04	400	400	30
	08	800	800	

Current Carrying Capacity

Frequency f				I_{TM}	Units
50Hz	250	420	408	640	2465 3460 A
400Hz	320	530	485	800	1470 2150 A
2500Hz	240	390	400	650	540 830 A
5000Hz	210	340	340	530	340 530 A
10000Hz	160	275	300	415	- - A
Recovery voltage V_r	50	50	50	50	50 50 V
Voltage before turn-on V_d	$80\%V_{DRM}$		$80\%V_{DRM}$		$80\%V_{DRM}$ V
Rise of on-state current dI/dt	50	50	-	-	- A/ μ s
Case temperature	90	60	90	60	90 60 $^\circ\text{C}$
Equivalent values for RC circuit	$47\Omega / 0.22\mu\text{F}$		$47\Omega / 0.22\mu\text{F}$		$47\Omega / 0.22\mu\text{F}$

On-state Conduction

Parameter	IRK.F132..	Units	Conditions
$I_{T(AV)}$	Maximum average on-state current @ Case temperature	A	180° conduction, half sine wave
	90	$^\circ\text{C}$	
$I_{T(RMS)}$	293	A	$T_C = 90^\circ\text{C}$, as AC switch
I_{TSM}	3210	A	Sinusoidal half wave, Initial $T_J = 125^\circ\text{C}$
	3360		
	2700		
	2825		
I^2t	51.5	KA ² s	Initial $T_J = 125^\circ\text{C}$
	47.0		
	36.5		
	33.3		
	515		
$I^2\sqrt{t}$	Maximum $I^2\sqrt{t}$ for fusing	KA ² /s	$t = 0$ to 10ms, no voltage reapplied
$V_{T(TO)1}$	Low level value of threshold voltage	V	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J$ max.
$V_{T(TO)2}$	High level value of threshold voltage		$(I > \pi \times I_{T(AV)})$, $T_J = T_J$ max.
r_{t1}	Low level value of on-state slope resistance	mW	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J$ max.
r_{t2}	High level value of on-state slope resistance		$(I > \pi \times I_{T(AV)})$, $T_J = T_J$ max.
V_{TM}	Maximum on-state voltage drop	V	$I_{pk} = 600\text{A}$, $T_J = T_J$ max., $t_p = 10\text{ms}$ sine pulse
I_H	Maximum holding current	mA	$T_J = 25^\circ\text{C}$, $I_T > 30\text{ A}$
I_L	Typical latching current	mA	$T_J = 25^\circ\text{C}$, $V_A = 12\text{V}$, $R_a = 6\Omega$, $I_g = 1\text{A}$

Switching

Parameter	IRK.F132..	Units	Conditions
di/dt Maximum non-repetitive rate of rise	800	A/μs	Gate drive 20V, 20Ω, tr ≤ 1ms, V _D = 80% V _{DRM} , T _J = 25°C
t _{rr} Maximum recovery time	2	μs	I _{TM} = 350A, di/dt = -25A/μs, V _R = 50V, T _J = 25°C
t _q Maximum turn-off time	L	μs	I _{TM} = 350A, T _J = 125°C, di/dt = -25A/μs,
	15		V _R = 50V, dv/dt = 400V/μs linear to 80% V _{DRM}

Blocking

Parameter	IRK.F132..	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	1000	V/μs	T _J = 125°C., exponential to = 67% V _{DRM}
V _{INS} RMS isolation voltage	3000	V	50 Hz, circuit to base, T _J = 25°C, t = 1 s
I _{RRM} I _{DRM} leakage current	30	mA	T _J = 125°C, rated V _{DRM} /V _{RRM} applied

Triggering

Parameter	IRK.F132..	Units	Conditions
P _{GM} Maximum peak gate power	60	W	f = 50 Hz, d% = 50
P _{G(AV)} Maximum peak average gate power	10	W	T _J = 125°C, f = 50Hz, d% = 50
I _{GM} Maximum peak positive gate current	10	A	T _J = 125°C, t _p ≤ 5ms
- V _{GM} Maximum peak negative gate voltage	5	V	
I _{GT} Max. DC gate current required to trigger	200	mA	T _J = 25°C, V _{ak} 12V, Ra = 6
V _{GT} DC gate voltage required to trigger	3	V	
I _{GD} DC gate current not to trigger	20	mA	T _J = 125°C, rated V _{DRM} applied
V _{GD} DC gate voltage not to trigger	0.25	V	

Thermal and Mechanical Specifications

Parameter	IRK.F132..	Units	Conditions
T _J Max. junction operating temperature range	- 40 to 125	°C	
T _{stg} Max. storage temperature range	- 40 to 150		
R _{thJC} Max. thermal resistance, junction to case	0.17	K/W	Per junction, DC operation
R _{thC-hs} Max. thermal resistance, case to heatsink	0.035	K/W	Mounting surface flat and greased Per module
T Mounting torque ± 10% IAP to heatsink busbar to IAP	4 - 6 (35 - 53)	Nm (lb*in)	A mounting compound is recommended. The torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Use of cable lugs is not recommended, busbars should be used and restrained during tightening. Threads must be lubricated with a compound
	4 - 6 (35 - 53)		
wt Approximate weight	500 (17.8)	g (oz)	

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Bulletin I27092 rev. A 09/97

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ΔR_{thJC} Conduction

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.016	0.011	K/W	$T_J = 125^\circ\text{C}$
120°	0.019	0.020		
90°	0.024	0.026		
60°	0.035	0.037		
30°	0.060	0.060		

Ordering Information Table

Device Code									
IRK	T	F	13	2	-	08	H	L	N
(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(8)	

1 - Module type
2 - Circuit configuration
3 - Fast SCR
4 - Current rating: $I_{T(AV)} \times 10$ rounded
5 - 1 = option with spacers and longer terminal screws
 2 = option with standard terminal screws
6 - Voltage code: Code $\times 100 = V_{RRM}$ (See Voltage Ratings Table)
7 - dv/dt code: $H \leq 400\text{V}/\mu\text{s}$
8 - t_q code: $L \leq 15\mu\text{s}$
9 - None = Standard devices
 N = Aluminum nitride substrate

NOTE: To order the Optional Hardware see Bulletin I27900

Outline Table

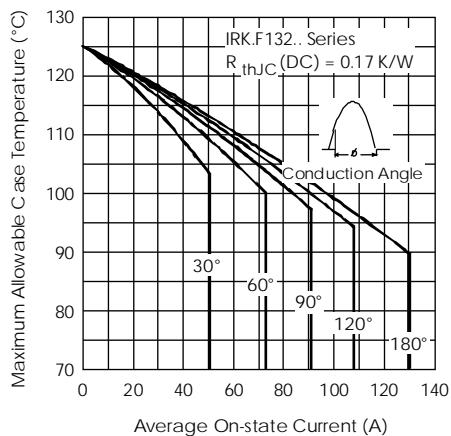
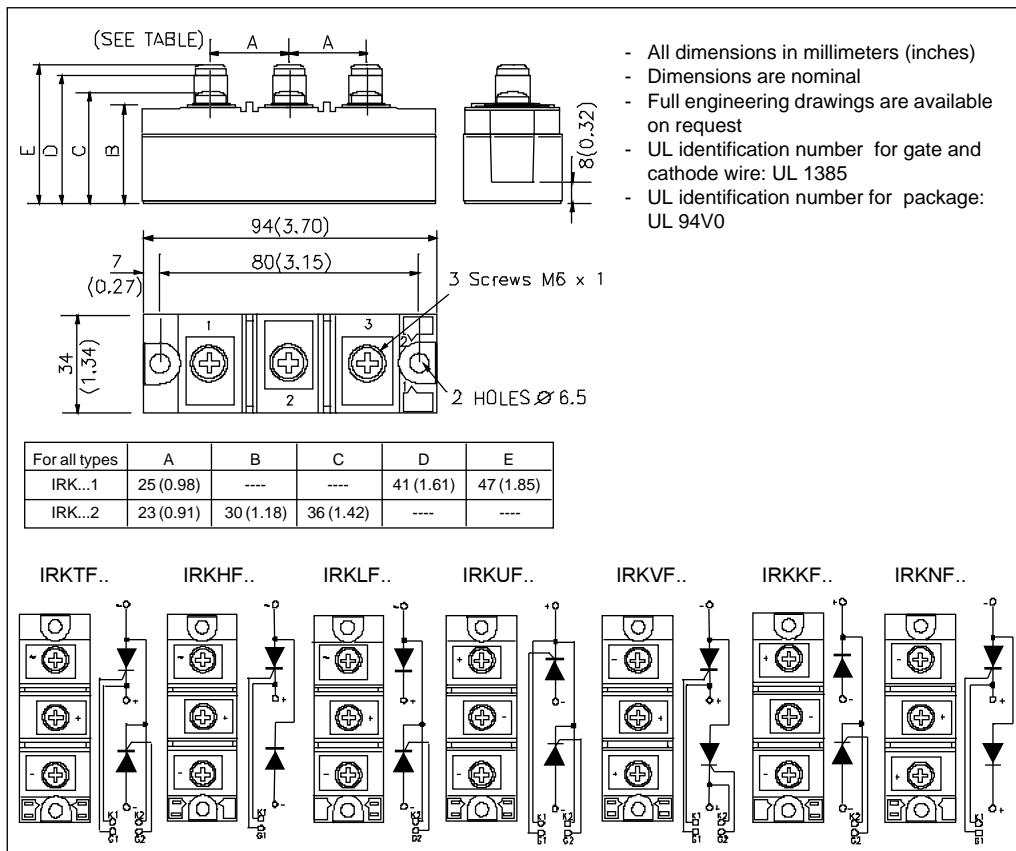


Fig. 1 - Current Ratings Characteristics

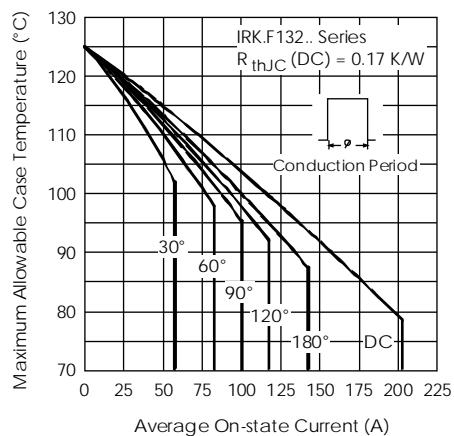


Fig. 2 - Current Ratings Characteristics

IRK.F132.. Series

Bulletin I27092 rev. A 09/97

International
IR Rectifier

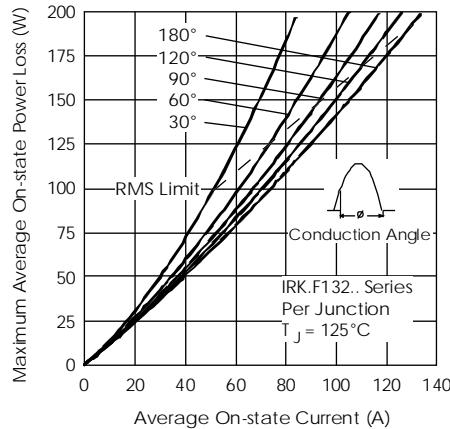


Fig. 3 - On-state Power Loss Characteristics

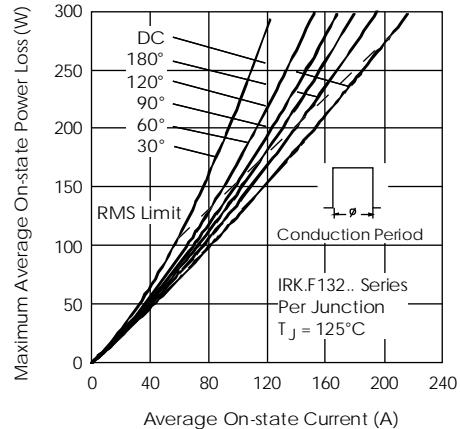


Fig. 4 - On-state Power Loss Characteristics

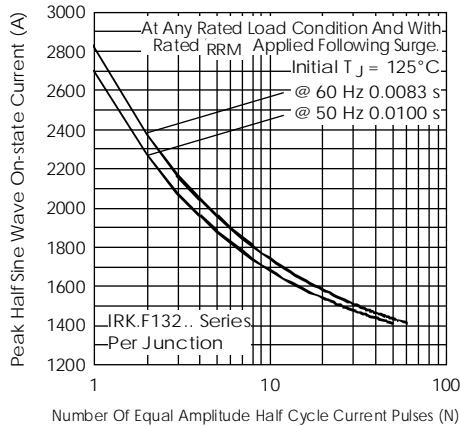


Fig. 5 - Maximum Non-Repetitive Surge Current

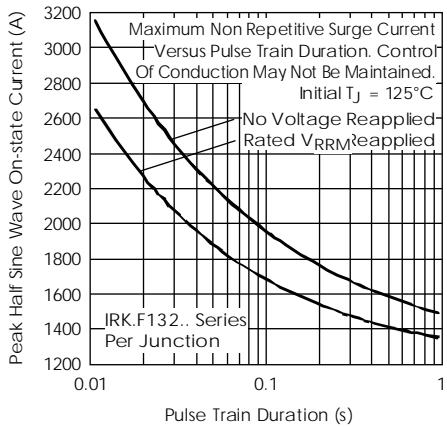


Fig. 6 - Maximum Non-Repetitive Surge Current

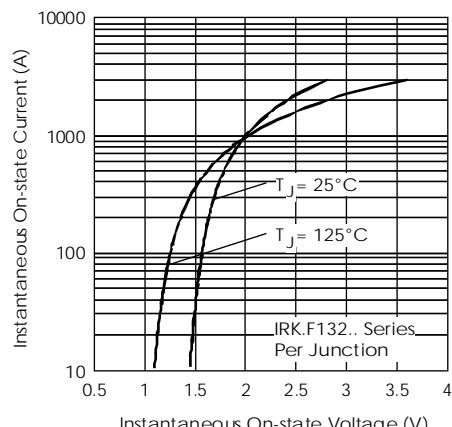


Fig. 7 - On-state Voltage Drop Characteristics

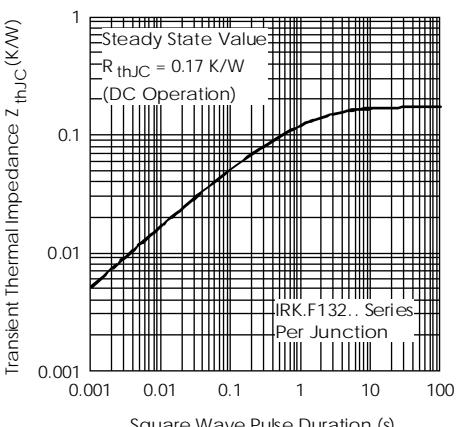


Fig. 8 - Thermal Impedance Z_{thJC} Characteristic

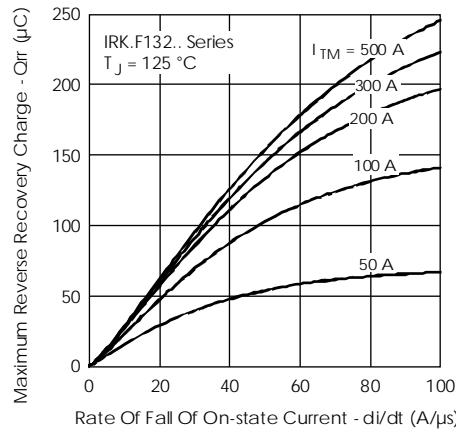


Fig. 9 - Reverse Recovery Charge Characteristics

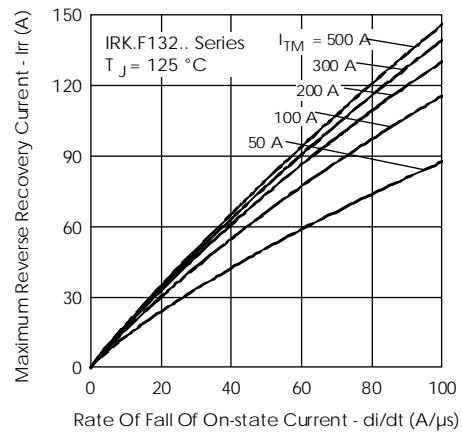


Fig. 10 - Reverse Recovery Current Characteristics

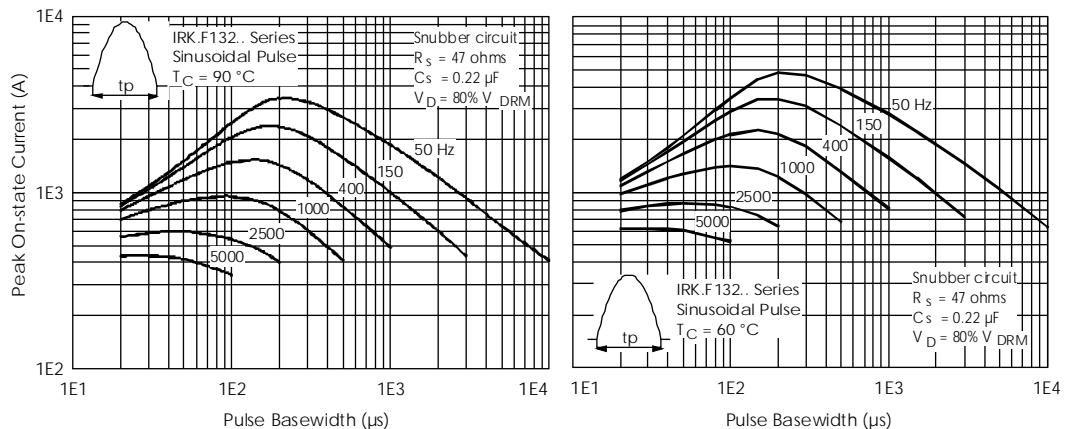


Fig. 11 - Frequency Characteristics

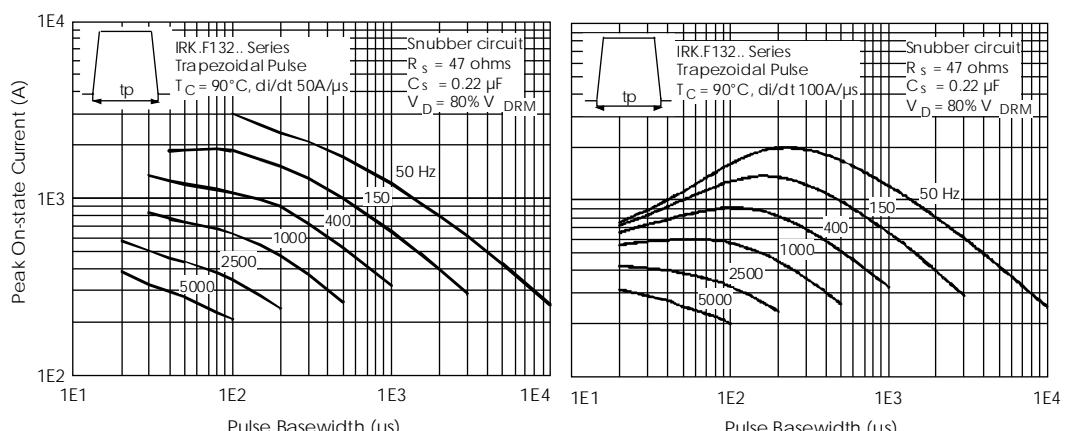


Fig. 12 - Frequency Characteristics

IRK.F132.. Series

Bulletin I27092 rev. A 09/97

International
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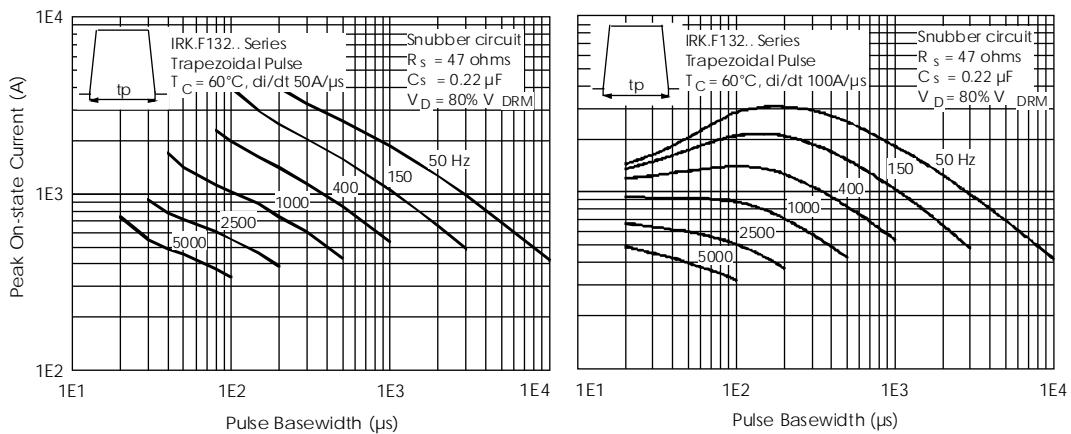


Fig. 13 - Frequency Characteristics

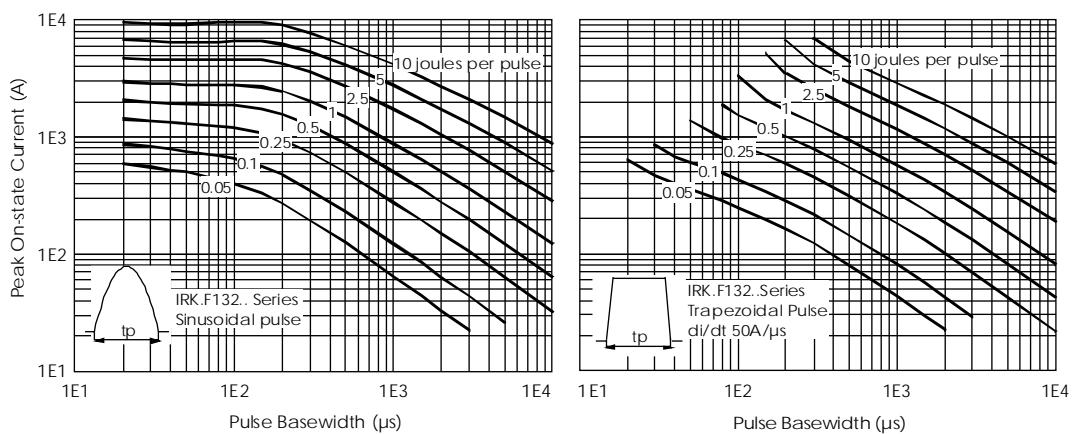


Fig. 14 - Maximum On-state Energy Power Loss Characteristics

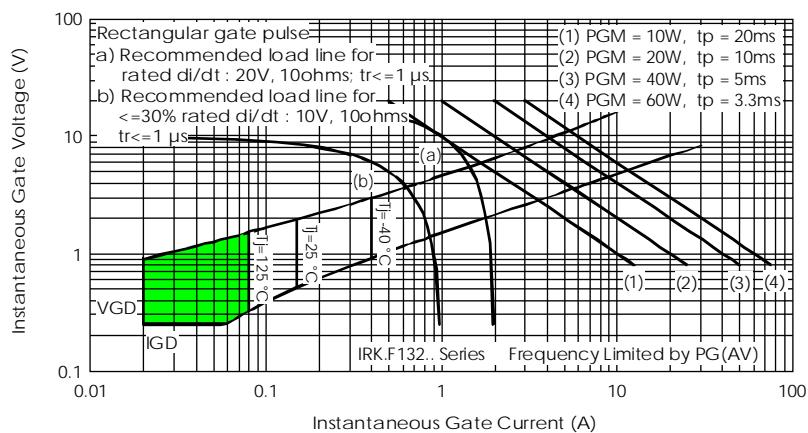


Fig. 15 - Gate Characteristics